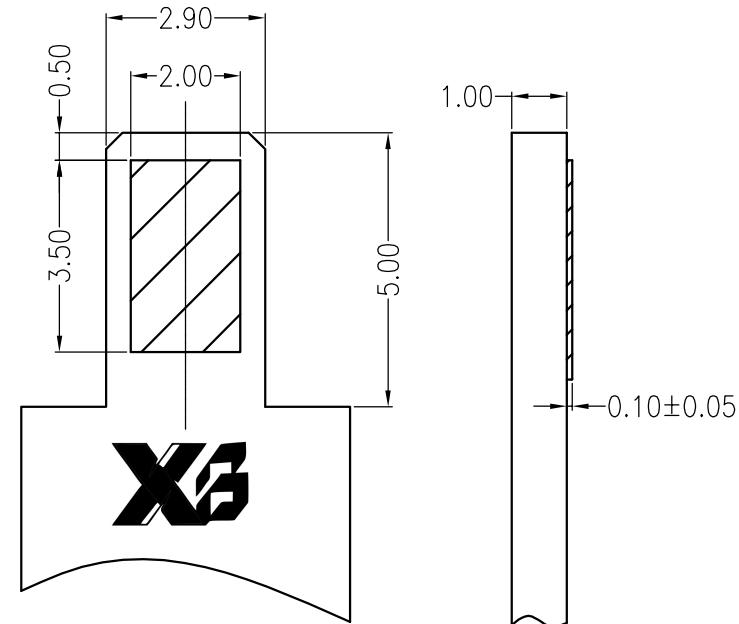
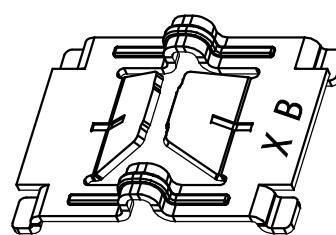
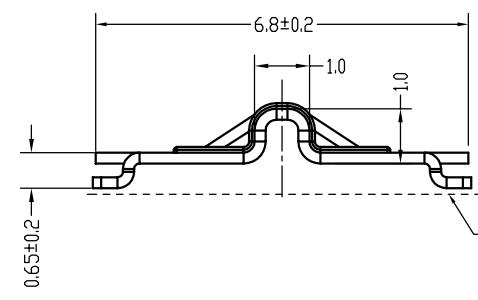
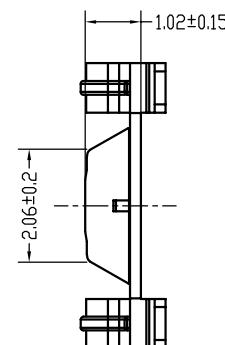
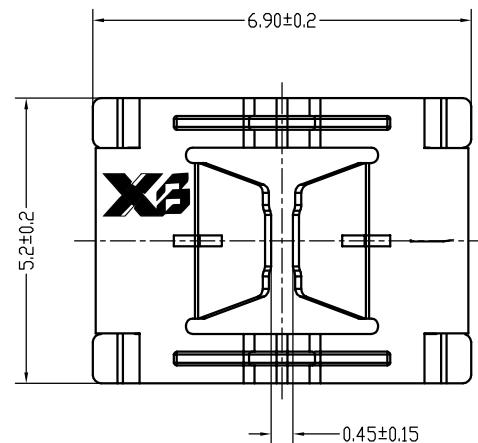


REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	吴丹平	2017.06.14



Mating PCB detail

主要技术参数 Main Specifications

板 厚 (thickness): 1.0mm

接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$

额定电压 (Rated voltage): 250 V AC/DC

额定电流 (Rated current): 1.0A AC

温度范围 (Temperature Range) : -45°C ~ +125°C

ORDER INFORMATION:

XB-1074K-01-000B1-B4

PART No. _____ 4=Wide mouth

1 No. FOR CIRCUITS: _____ 2 _____ PACKAGING: _____

01 R=REEL
PLASTIC MATERIAL: METAL CODE:

PLASTIC MATERIAL: _____
000=No plastic parts 1=PhosphorBron
PLATENS

PLATING:
B=MATTE Sn

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Board Layout